MOSFET – Power, Single, **N-Channel 30 V, 4.1 mΩ, 90 A**

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Parameter Drain-to-Source Voltage			Symbol	Value 30	Unit V
			V _{DSS}		
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady State	$T_{C} = 25^{\circ}C$	I _D	90	A
Current R _{0JC} (Notes 1 & 3)		$T_{C} = 100^{\circ}C$		64	
Power Dissipation $R_{\theta JC}$ (Note 1)		$T_{C} = 25^{\circ}C$	PD	57	W
		$T_{C} = 100^{\circ}C$		28	
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2 & 3)	Steady State	$T_A = 25^{\circ}C$	۱ _D	22	А
		T _A = 100°C		16	
Power Dissipation $R_{\theta JA}$ (Notes 1 & 2)		$T_A = 25^{\circ}C$	PD	3.5	W
		$T_A = 100^{\circ}C$		1.7	
Pulsed Drain Current	T _A = 25°	C, t _p = 10 μs	I _{DM}	395	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 175	°C
Source Current (Body Diode)			۱ _S	75	А
Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, $I_{L(pk)}$ = 6.9 A)			E _{AS}	133	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

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Str device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain) (Note 1)	$R_{\theta JC}$	2.65	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	43	

The entire application environment impacts the thermal resistance values shown, 1. they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

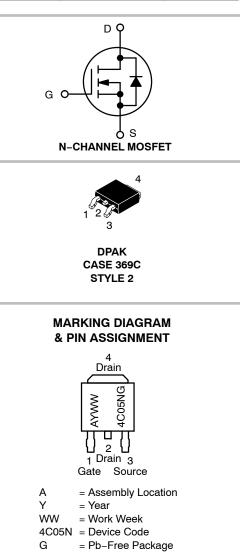
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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V _{(BR)DSS}	R _{DS(on)}	ID
30 V	4.1 mΩ @ 10 V	90 A
30 V	6.0 mΩ @ 4.5 V	30 A



ORDERING INFORMATION See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

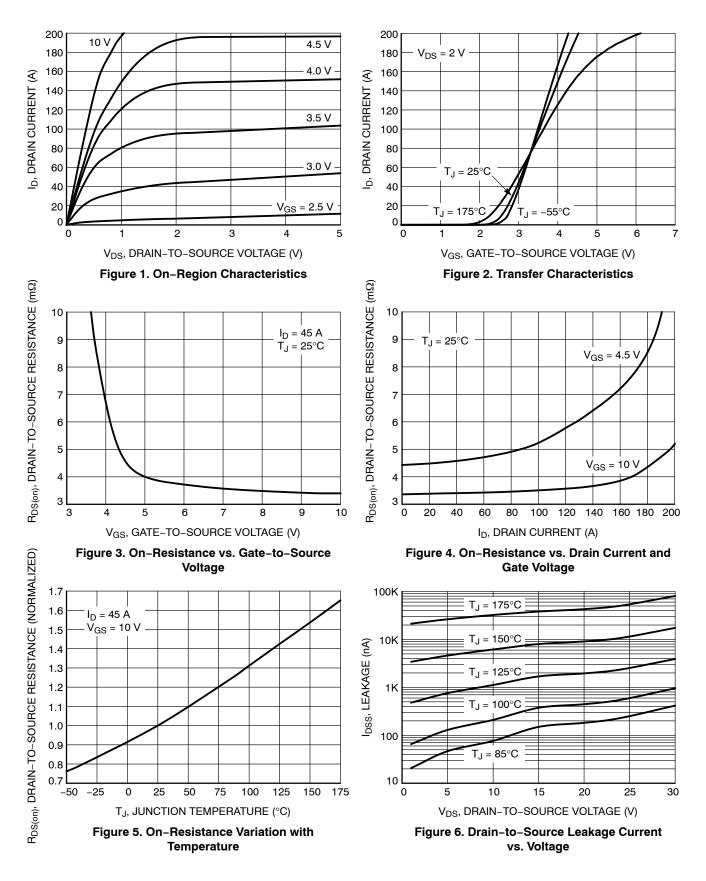
ELECTRICAL CHARACTERISTICS (T = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				14.9		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V_{CS}$	T _J = 25°C			1.0	μΑ
		V _{GS} = 0 V, V _{DS} = 24 V	T _J = 125°C			10	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	= 250 μA	1.3		2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.7		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I _D	= 45 A		3.4	4.1	mΩ
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{\text{E}}$	₀ = 45 A		4.5	6.0	
Forward Transconductance	9 FS	V _{DS} = 2 V, I _D = 45 A			98		S
CHARGES, CAPACITANCES AND GATE RE	SISTANCES						
Input Capacitance	C _{iss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 25 V			1970		pF
Output Capacitance	C _{oss}				725		
Reverse Transfer Capacitance	C _{rss}				30		
Total Gate Charge	Q _{G(TOT)}	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \text{ V}, V_{DS} = 24 \text{ V}, \\ I_D = 45 \text{ A} \end{array}$			31		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 24 V, I _D = 45 A			14		nC
Threshold Gate Charge	Q _{G(TH)}				3.3		
Gate-to-Source Charge	Q _{GS}				6.2		1
Gate-to-Drain Charge	Q _{GD}				3.2		1
Plateau Voltage	V _{GP}				3.1		V
Gate Resistance	R _G				1.0		Ω
SWITCHING CHARACTERISTICS (Note 5)							
Turn-On Delay Time	t _{d(on)}	V_{GS} = 4.5 V, V_{DS} = 24 V, I_{D} = 45 A, R_{G} = 0 Ω			11		ns
Rise Time	t _r				107		
Turn-Off Delay Time	t _{d(off)}				17		
Fall Time	t _f				6.0		1
DRAIN-SOURCE DIODE CHARACTERISTIC	s						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 45 A$	T _J = 25°C		0.9	1.2	V
			T _J = 125°C		0.8		1
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dls/dt = 100 A/μs, I _S = 45 A			41		ns
Charge Time	ta				21		1
Discharge Time	tb				20		1
Reverse Recovery Charge	Q _{RR}				26		nC

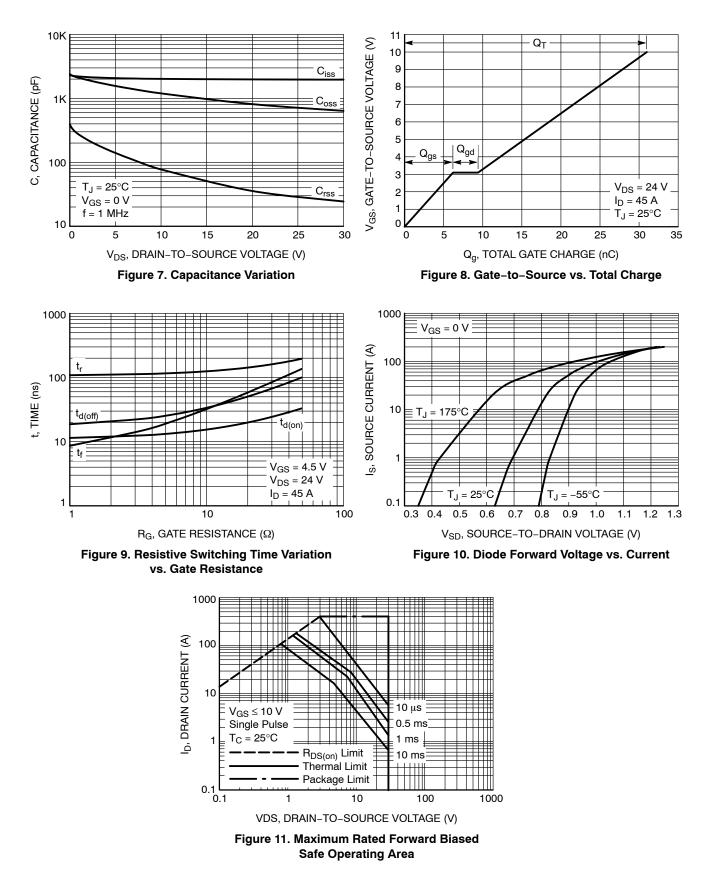
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

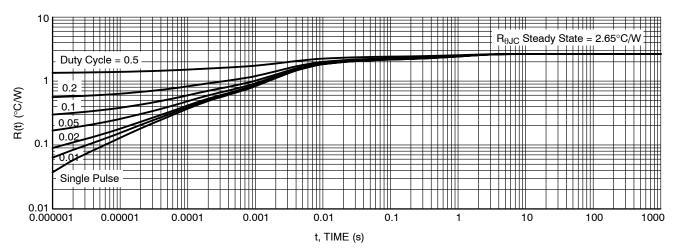
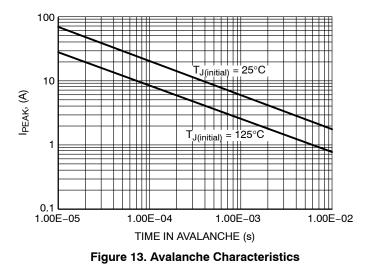


Figure 12. Thermal Impedance (Junction-to-Case)

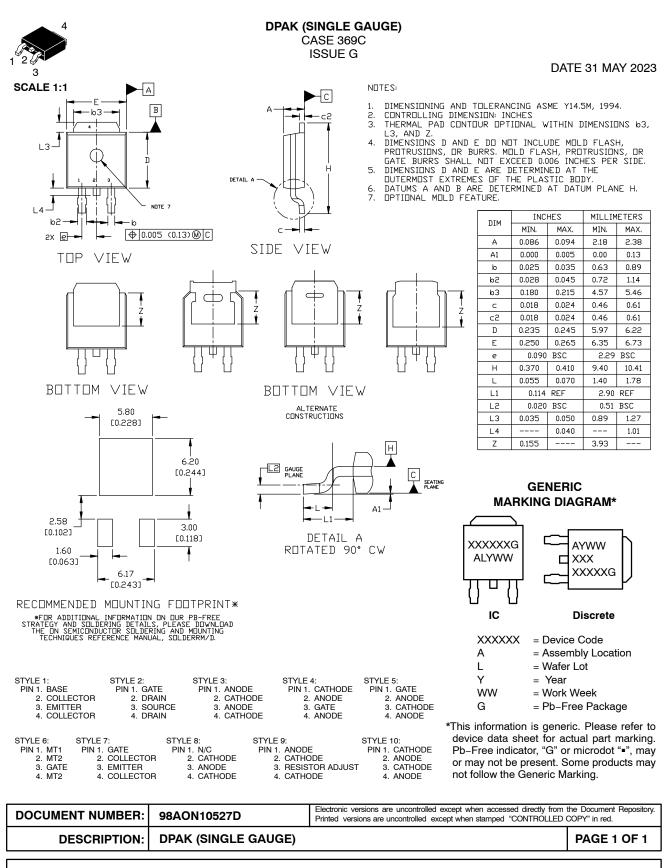


ORDERING INFORMATION

Order Number	Package	Shipping [†]
NVD4C05NT4G	DPAK (Pb–Free)	2500 / Tape & Reel

⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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